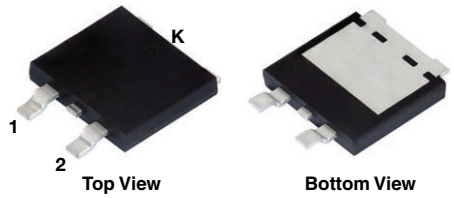
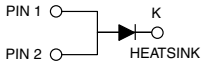
Surface Mount ESD Capability Rectifiers

eSMP® Series
TO-263AC (SMPD)



Top View Bottom View

SE10DX



FEATURES

- Very low profile - typical height of 1.7 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop
- ESD capability
- AEC-Q101 qualified
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT
HALOGEN FREE

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both consumer and automotive applications.

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	10 A
V_{RRM}	100 V, 200 V, 400 V, 600 V
I_{FSM}	110 A
V_F at I_F = 10 A (T_A = 125 °C)	0.96 V
I_R	15 µA
T_J max.	175 °C
Package	TO-263AC (SMPD)
Diode variations	Single

MECHANICAL DATA

Case: TO-263AC (SMPD)
Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade
Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102
M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: As marked

MAXIMUM RATINGS (T_A = 25 °C unless otherwise noted)

PARAMETER	SYMBOL	SE10DB	SE10DD	SE10DG	SE10DJ	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	100	200	400	600	V
Maximum DC forward current	I_F (1)	10				A
	I_F (2)	3.0				
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I_{FSM}	110				A
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +175				°C

Notes
(1) With heatsink
(2) Free air, mounted on recommended copper pad area

ELECTRICAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)						
PARAMETER	**TEST CONDITIONS**		**SYMBOL**	**TYP.**	**MAX.**	**UNIT**
Instantaneous forward voltage	I_F = 5 A	T_A = 25 °C	V_F (1)	0.95	-	V
	I_F = 10 A			1.04	1.15	
	I_F = 5 A	T_A = 125 °C		0.85	-	
	I_F = 10 A			0.96	1.10	
Reverse current	Rated V_R	T_A = 25 °C	I_R (2)	-	15	µA
		T_A = 125 °C		22	150	
Typical reverse recovery time	I_F = 0.5 A, I_R = 1.0 A, I_{rr} = 0.25 A		t_{rr}	3000	-	ns
Typical junction capacitance	4.0 V, 1 MHz		C_J	67	-	pF

Notes
(1) Pulse test: 300 µs pulse width, 1 % duty cycle
(2) Pulse test: Pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T_A = 25 °c unless otherwise noted)						
PARAMETER	**SYMBOL**	**SE10DB**	**SE10DD**	**SE10DG**	**SE10DJ**	**UNIT**
Typical thermal resistance	$R_{\theta JA}$ (1)	60				°C/W
	$R_{\theta JM}$ (2)	1.6				

Notes
(1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient
(2) With heatsink

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS (T_A = 25 °C unless otherwise noted)					
STANDARD	**TEST TYPE**	**TEST CONDITIONS**	**SYMBOL**	**CLASS**	**VALUE**
AEC-Q101-001	Human body model (contact mode)	C = 100 pF, R = 1.5 kΩ	V_C	H3B	> 8 kV

ORDERING INFORMATION (Example)					
STANDARD	**PREFERRED P/N**	**UNIT WEIGHT (g)**	**PREFERRED PACKAGE CODE**	**BASE QUANTITY**	**DELIVERY MODE**
TO-263AC (SMPD)	SE10DJ-M3/I	0.54	I	2000/reel	13" diameter plastic tape and reel
TO-263AC (SMPD)	SE10DJHM3/I (1)	0.54	I	2000/reel	13" diameter plastic tape and reel

Note
(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

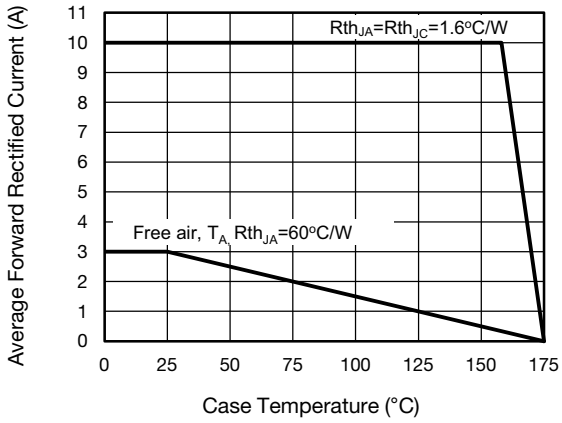


Fig. 1 - Forward Current Derating Curve

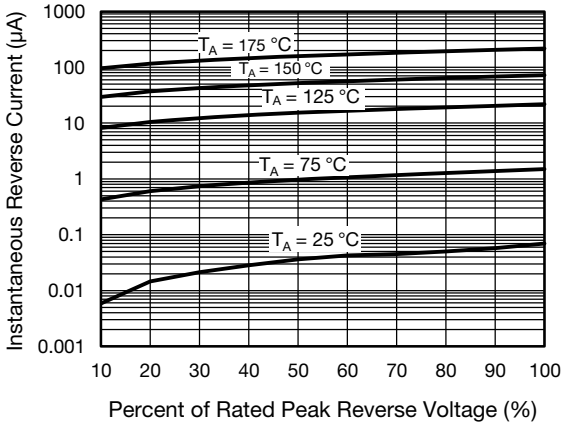


Fig. 4 - Typical Reverse Leakage Characteristics

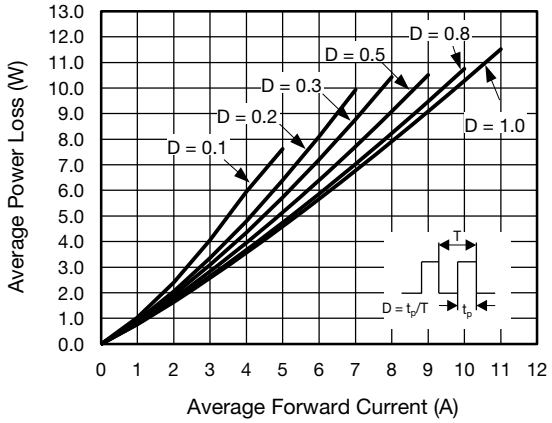


Fig. 2 - Forward Power Loss Characteristics

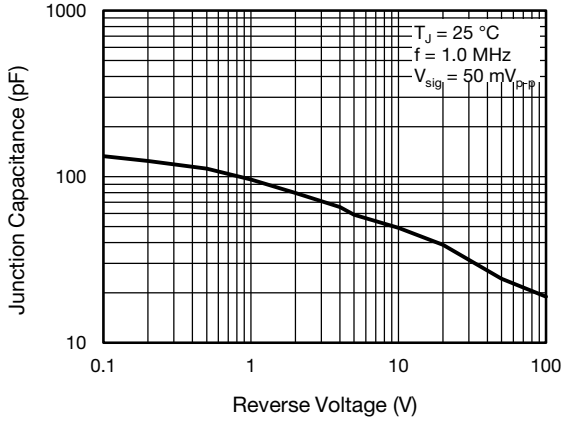


Fig. 5 - Typical Junction Capacitance

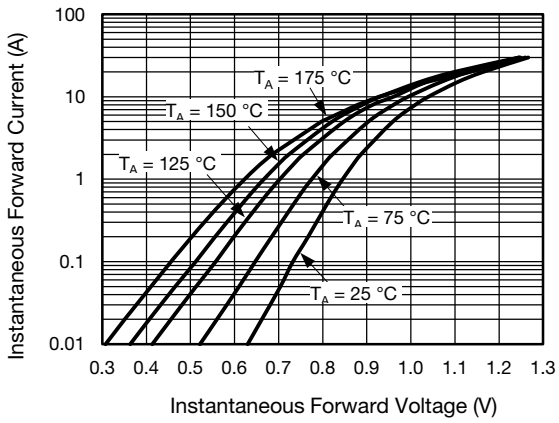


Fig. 3 - Typical Instantaneous Forward Characteristics

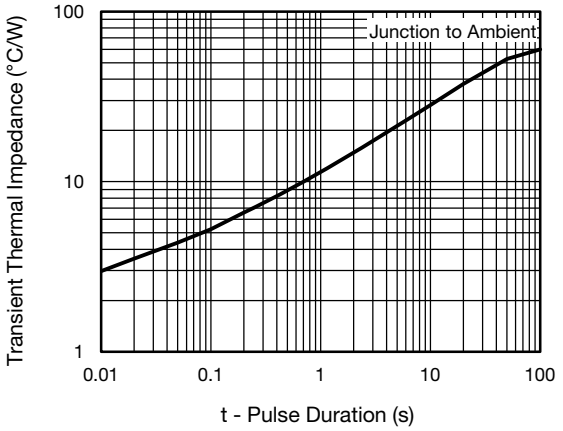
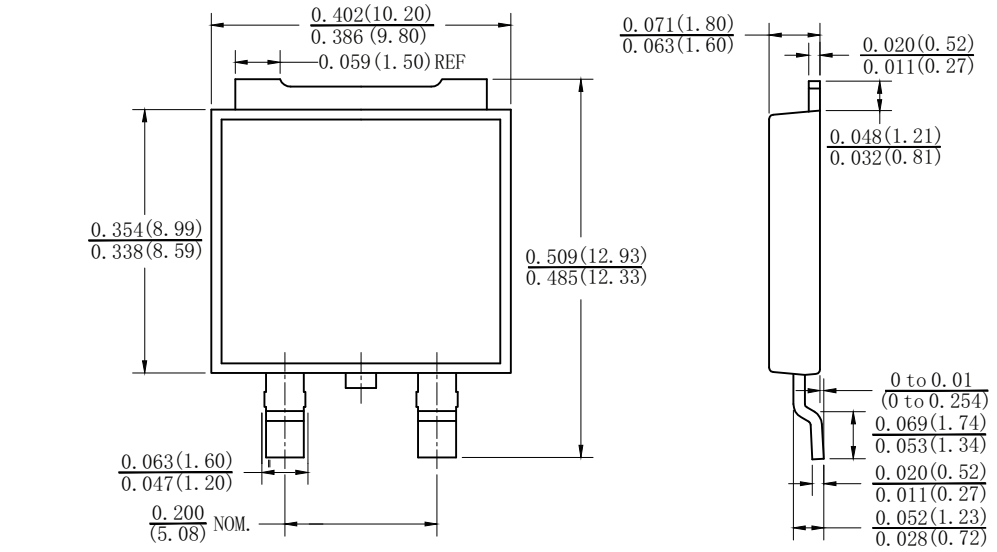


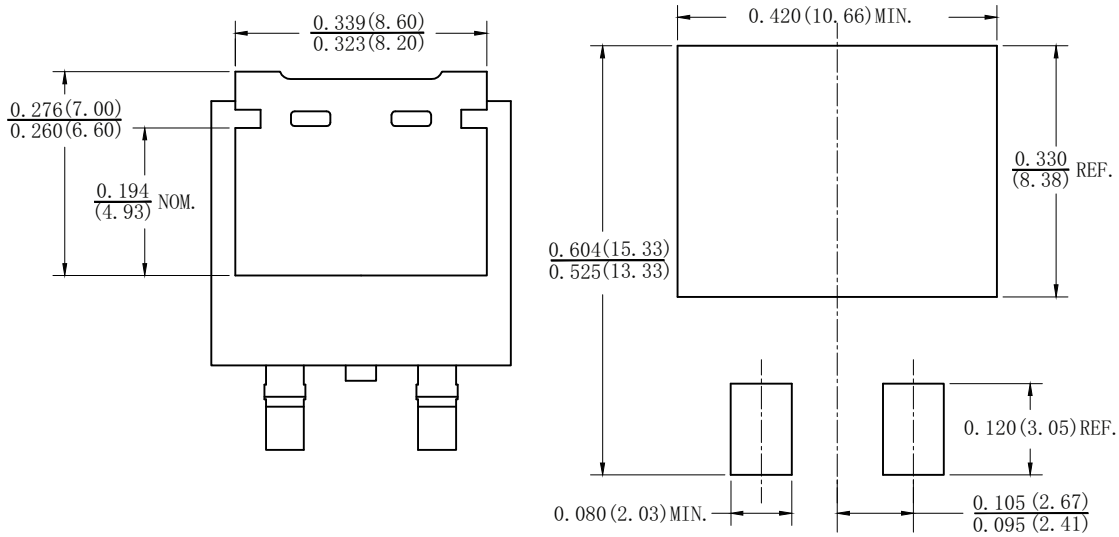
Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

TO-263AC (SMPD)



Mounting Pad Layout



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